

256K I²CTM Serial EEPROM with EUI-48TM, EUI-64TM and Unique 32-Bit Serial Number

Device Selection Table

| Part Number | Vcc Range | Max. Clock Frequency | Temp. Ranges | Page Size | EUI-48™ | EUI-64™ | Unique ID Length |
|-------------|--------------|-------------------------|-----------------|--------------|---------|---------|---------------------|
| 24AA256UID | 1.7-5.5V | 400 kHz ⁽¹⁾ | I | 64-byte | Yes | Yes | 32-bit |

Note 1: 100 kHz for Vcc < 2.5V.

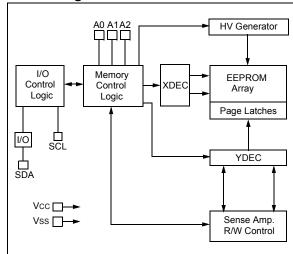
Features:

- · Pre-Programmed 32-Bit Serial Number:
 - Unique across all UID-family EEPROMs
 - Scalable to 48-bit, 64-bit, 128-bit, 256-bit, and other lengths
- Pre-Programmed Globally Unique, 48-bit or 64-bit Node Address:
 - Compatible with EUI-48™ and EUI-64™
- Codes Stored in Permanently Write-Protected Upper 1/8th of EEPROM Array
- · Single Supply with Operation Down to 1.7V
- Low-Power CMOS Technology:
 - Active current 400 uA, typical
 - Standby current 100 nA, typical
- 2-Wire Serial Interface, I²C[™] Compatible
- · Cascadable up to Eight Devices
- · Schmitt Trigger Inputs for Noise Suppression
- · Output Slope Control to Eliminate Ground Bounce
- · 100 kHz and 400 kHz Clock Compatibility
- · Page Write Time 5 ms Max.
- · Self-Timed Erase/Write Cycle
- 64-Byte Page Write Buffer
- ESD Protection >4000V
- · More than One Million Erase/Write Cycles
- · Data Retention >200 years
- Packages Include 8-lead PDIP, SOIC and TSSOP
- · RoHS Compliant
- Temperature Ranges:
 - Industrial (I): -40°C to +85°C

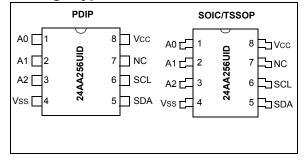
Description:

The Microchip Technology Inc. 24AA256UID is a 32K x 8 (256 Kbit) Serial Electrically Erasable PROM with pre-programmed EUI-48 and EUI-64 node addresses and a 32-bit Unique ID, capable of operation across a broad voltage range (1.7V to 5.5V). This device also has a page write capability of up to 64 bytes of data. This device is available in the standard 8-pin plastic DIP, SOIC and TSSOP packages.

Block Diagram



Package Types



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings(†)

| Vcc | 6.5\ |
|--|-------------------|
| All inputs and outputs w.r.t. Vss | 0.6V to Vcc +1.0\ |
| Storage temperature | 65°C to +150°C |
| Ambient temperature with power applied | 40°C to +85°C |
| ESD protection on all pins | ≥ 4 k\ |

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TABLE 1-1: DC CHARACTERISTICS

| DC CHA | RACTERI | STICS | Electrical Characteristics: Industrial (I): VCC = +1.7V to 5.5V TA = -40°C to +85°C | | | | |
|---------------|--------------|--|--|--------------------|--------|---|--|
| Param. No. | Sym. | Characteristic | Min. | Max. | Units | Conditions | |
| | _ | A0, A1, A2, SCL and SDA pins: | _ | _ | _ | _ | |
| D1 | VIH | High-level input voltage | 0.7 Vcc | _ | V | _ | |
| D2 | VIL | Low-level input voltage | _ | 0.3 Vcc 0.2 Vcc | V V | Vcc ≥ 2.5V Vcc < 2.5V | |
| D3 | VHYS | Hysteresis of Schmitt Trigger inputs (SDA, SCL pins) | 0.05 Vcc | _ | V | Vcc ≥ 2.5V (Note) | |
| D4 | Vol | Low-level output voltage | _ | 0.40 | V | IOL = 3.0 mA @ VCC = 4.5V IOL = 2.1 mA @ VCC = 2.5V | |
| D5 | ILI | Input leakage current | _ | ±1 | μΑ | VIN = VSS or VCC | |
| D6 | ILO | Output leakage current | _ | ±1 | μΑ | Vout = Vss or Vcc | |
| D7 | CIN, COUT | Pin capacitance (all inputs/outputs) | _ | 10 | pF | Vcc = 5.0V (Note) TA = 25°C, Fclk = 1 MHz | |
| D8 | Icc Read | Operating current | _ | 400 | μΑ | Vcc = 5.5V, SCL = 400 kHz | |
| | Icc Write | | _ | 3 | mA | Vcc = 5.5V | |
| D9 | Iccs | Standby current | _ | 1 | μА | TA = -40°C to +85°C SCL = SDA = Vcc = 5.5V A0, A1, A2 = Vss | |

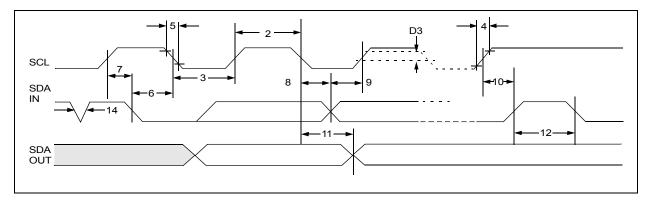
Note: This parameter is periodically sampled and not 100% tested.

TABLE 1-2: AC CHARACTERISTICS

| AC CHA | ARACTER | ISTICS | Electrical Characteristics: Industrial (I): VCC = +1.7V to 5.5V TA = -40°C to | | | |
|---------------|---------|--|---|-------------|--------|--|
| Param. No. | Sym. | Characteristic | Min. | Max. | Units | Conditions |
| 1 | FCLK | Clock frequency | _ | 100 400 | kHz | 1.7V ≤ Vcc < 2.5V 2.5V ≤ Vcc ≤ 5.5V |
| 2 | THIGH | Clock high time | 4000 600 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 3 | TLOW | Clock low time | 4700 1300 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 4 | TR | SDA and SCL rise time (Note 1) | _ | 1000 300 | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 5 | TF | SDA and SCL fall time (Note 1) | _ | 300 | ns | _ |
| 6 | THD:STA | Start condition hold time | 4000 600 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 7 | Tsu:sta | Start condition setup time | 4700 600 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 8 | THD:DAT | Data input hold time | 0 | _ | ns | (Note 2) |
| 9 | Tsu:dat | Data input setup time | 250 100 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 10 | Tsu:sto | Stop condition setup time | 4000 600 | _ | ns | 1.7V ≤ VCC < 2.5V 2.5V ≤ VCC ≤ 5.5V |
| 11 | TAA | Output valid from clock (Note 2) | _ _ | 3500 900 | ns | 1.7 V ≤ VCC < 2.5V 2.5 V ≤ VCC ≤ 5.5V |
| 12 | TBUF | Bus free time: Time the bus must be free before a new transmission can start | 4700 1300 | _ | ns | 1.7V ≤ Vcc < 2.5V 2.5V ≤ Vcc ≤ 5.5V |
| 13 | TOF | Output fall time from VIH minimum to VIL maximum CB ≤ 100 pF | 10 + 0.1CB | 250 | ns | (Note 1) |
| 14 | TSP | Input filter spike suppression (SDA and SCL pins) | _ | 50 | ns | (Notes 1 and 3) |
| 15 | Twc | Write cycle time (byte or page) | _ | 5 | ms | _ |
| 16 | _ | Endurance | 1,000,000 | _ | cycles | Page mode, 25°C, 5.5V (Note 4) |

- **Note 1:** Not 100% tested. CB = total capacitance of one bus line in pF.
 - **2:** As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.
 - **3:** The combined TsP and VHYS specifications are due to new Schmitt Trigger inputs, which provide improved noise spike suppression. This eliminates the need for a Ti specification for standard operation.
 - **4:** This parameter is not tested but ensured by characterization. For endurance estimates in a specific application, please consult the Total Endurance™ Model, which can be obtained from Microchip's web site at www.microchip.com.

FIGURE 1-1: BUS TIMING DATA



2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

| Name | 8-pin PDIP | 8-pin SOIC | 8-pin TSSOP | Function |
|------|---------------|---------------|----------------|-------------------------------|
| A0 | 1 | 1 | 1 | User Configurable Chip Select |
| A1 | 2 | 2 | 2 | User Configurable Chip Select |
| A2 | 3 | 3 | 3 | User Configurable Chip Select |
| Vss | 4 | 4 | 4 | Ground |
| SDA | 5 | 5 | 5 | Serial Data |
| SCL | 6 | 6 | 6 | Serial Clock |
| NC | 7 | 7 | 7 | Not Connected |
| Vcc | 8 | 8 | 8 | +1.7V to 5.5V |

2.1 A0, A1, A2 Chip Address Inputs

The A0, A1 and A2 inputs are used by the 24AA256UID for multiple device operations. The levels on these inputs are compared with the corresponding bits in the slave address. The chip is selected if the compare is true.

Up to eight devices may be connected to the same bus by using different Chip Select bit combinations. These inputs must be connected to either Vcc or Vss.

In most applications, the chip address inputs A0, A1 and A2 are hard-wired to logic '0' or logic '1'. For applications in which these pins are controlled by a microcontroller or other programmable device, the chip address pins must be driven to logic '0' or logic '1' before normal device operation can proceed.

2.2 Serial Data (SDA)

This is a bidirectional pin used to transfer addresses and data into and out of the device. It is an open drain terminal. Therefore, the SDA bus requires a pull-up resistor to VCC (typical 10 k Ω for 100 kHz, 2 k Ω for 400 kHz).

For normal data transfer, SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the Start and Stop conditions.

2.3 Serial Clock (SCL)

This input is used to synchronize the data transfer to and from the device.

3.0 FUNCTIONAL DESCRIPTION

The 24AA256UID supports a bidirectional 2-wire bus and data transmission protocol. A device that sends data onto the bus is defined as a transmitter and a device receiving data as a receiver. The bus must be controlled by a master device which generates the Serial Clock (SCL), controls the bus access, and generates the Start and Stop conditions while the 24AA256UID works as a slave. Both master and slave can operate as a transmitter or receiver, but the master device determines which mode is activated.

4.0 BUS CHARACTERISTICS

The following bus protocol has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high. Changes in the data line, while the clock line is high, will be interpreted as a Start or Stop condition.

Accordingly, the following bus conditions have been defined (Figure 4-1).

4.1 Bus Not Busy (A)

Both data and clock lines remain high.

4.2 Start Data Transfer (B)

A high-to-low transition of the SDA line while the clock (SCL) is high, determines a Start condition. All commands must be preceded by a Start condition.

4.3 Stop Data Transfer (C)

A low-to-high transition of the SDA line, while the clock (SCL) is high, determines a Stop condition. All operations must end with a Stop condition.

4.4 Data Valid (D)

The state of the data line represents valid data when, after a Start condition, the data line is stable for the duration of the high period of the clock signal.

The data on the line must be changed during the low period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a Start condition and terminated with a Stop condition. The number of the data bytes transferred between the Start and Stop conditions is determined by the master device.

4.5 Acknowledge

Each receiving device, when addressed, is obliged to generate an Acknowledge signal after the reception of each byte. The master device must generate an extra clock pulse which is associated with this Acknowledge bit

Note: The 24AA256UID does not generate any Acknowledge bits if an internal programming cycle is in progress.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable-low during the high period of the acknowledge-related clock pulse. Of course, setup and hold times must be taken into account. During reads, a master must signal an end of data to the slave by NOT generating an Acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave (24AA256UID) will leave the data line high to enable the master to generate the Stop condition.

24AA256UID

FIGURE 4-1: DATA TRANSFER SEQUENCE ON THE SERIAL BUS

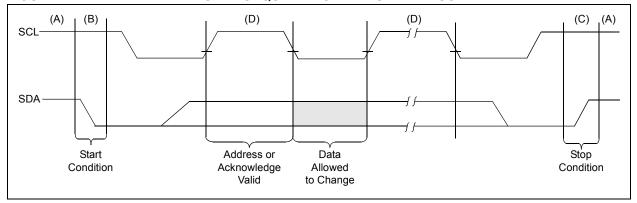
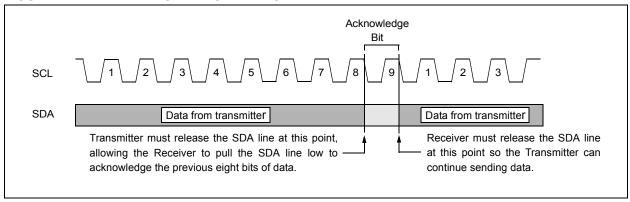


FIGURE 4-2: ACKNOWLEDGE TIMING



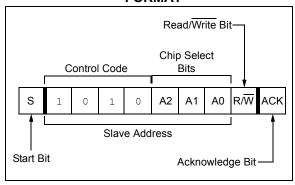
5.0 DEVICE ADDRESSING

A control byte is the first byte received following the Start condition from the master device (Figure 5-1). The control byte consists of a 4-bit control code. For the 24AA256UID, this is set as '1010' binary for read and write operations. The next three bits of the control byte are the Chip Select bits (A2, A1, A0). The Chip Select bits allow the use of up to eight 24AA256UID devices on the same bus and are used to select which device is accessed. The Chip Select bits in the control byte must correspond to the logic levels on the corresponding A2, A1 and A0 pins for the device to respond. These bits are, in effect, the three Most Significant bits of the word address.

The last bit of the control byte defines the operation to be performed. When set to a one, a read operation is selected. When set to a zero, a write operation is selected. The next two bytes received define the address of the first data byte (Figure 5-2). Because only A14...A0 are used, the upper address bits are a "don't care." The upper address bits are transferred first, followed by the Less Significant bits.

Following the Start condition, the 24AA256UID monitors the SDA bus checking the device type identifier being transmitted. Upon receiving a '1010' code and appropriate device select bits, the slave device outputs an Acknowledge signal on the SDA line. Depending on the state of the R/W bit, the 24AA256UID will select a read or write operation.

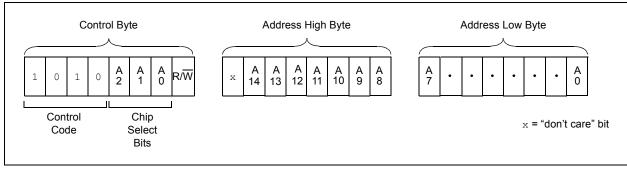
FIGURE 5-1: CONTROL BYTE FORMAT



5.1 Contiguous Addressing Across Multiple Devices

The Chip Select bits A2, A1 and A0 can be used to expand the contiguous address space for up to 2 Mbit by adding up to eight 24AA256UID devices on the same bus. In this case, software can use A0 of the **control byte** as address bit A15; A1 as address bit A16; and A2 as address bit A17. It is not possible to sequentially read across device boundaries.

FIGURE 5-2: ADDRESS SEQUENCE BIT ASSIGNMENTS



6.0 WRITE OPERATIONS

6.1 Byte Write

Following the Start condition from the master, the control code (four bits), the Chip Select (three bits) and the R/W bit (which is a logic low) are clocked onto the bus by the master transmitter. This indicates to the addressed slave receiver that the address high byte will follow after it has generated an Acknowledge bit during the ninth clock cycle. Therefore, the next byte transmitted by the master is the high-order byte of the word address and will be written into the Address Pointer of the 24AA256UID. The next byte is the Least Significant Address Byte. After receiving another Acknowledge signal from the 24AA256UID, the master device will transmit the data word to be written into the addressed memory location. The 24AA256UID acknowledges again and the master generates a Stop condition. This initiates the internal write cycle and during this time, the 24AA256UID will not generate Acknowledge signals (Figure 6-1).

Note:

When doing a write of less than 64 bytes the data in the rest of the page is refreshed along with the data bytes being written. This will force the entire page to endure a write cycle, for this reason endurance is specified per page.

6.2 Page Write

The write control byte, word address and the first data byte are transmitted to the 24AA256UID in much the same way as in a byte write. The exception is that instead of generating a Stop condition, the master transmits up to 63 additional bytes, which are temporarily stored in the on-chip page buffer, and will be written into memory once the master has transmitted a Stop condition. Upon receipt of each word, the six lower Address Pointer bits are internally incremented by one. If the master should transmit more than 64 bytes prior to generating the Stop condition, the address counter will roll over and the previously received data will be overwritten. As with the byte write operation, once the Stop condition is received, an internal write cycle will begin (Figure 6-2).

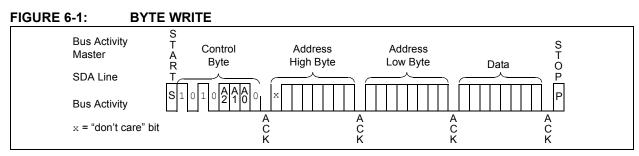
6.3 Write Protection

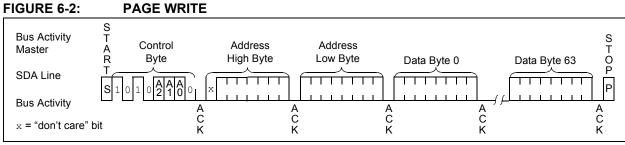
The upper eighth of the array (7000h-7FFFh) is permanently write-protected. Write operations to this address range are inhibited. Read operations are not affected.

The remainder of the array (0000h-6FFFh) can be written to and read from normally.

Note:

Page write operations are limited to writing bytes within a single physical page, regardless of the number of bytes actually being written. Physical page boundaries start at addresses that are integer multiples of the page buffer size (or 'page size') and end at addresses that are integer multiples of [page size - 1]. If a Page Write command attempts to write across a physical page boundary, the result is that the data wraps around to the beginning of the current page (overwriting data previously stored there), instead of being written to the next page, as might be expected. It is, therefore, necessary for the application software to prevent page write operations that would attempt to cross a page boundary.

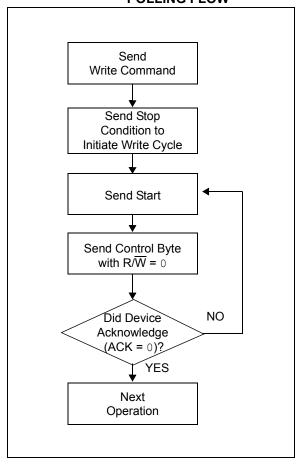




7.0 ACKNOWLEDGE POLLING

Since the device will not acknowledge during a write cycle, this can be used to determine when the cycle is complete (This feature can be used to maximize bus throughput). Once the Stop condition for a Write command has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a Start condition, followed by the control byte for a Write command (R/ \overline{W} = 0). If the device is still busy with the write cycle, then no ACK will be returned. If no ACK is returned, the Start bit and control byte must be resent. If the cycle is complete, then the device will return the ACK and the master can then proceed with the next Read or Write command. See Figure 7-1 for the flow diagram.

FIGURE 7-1: ACKNOWLEDGE POLLING FLOW



8.0 READ OPERATION

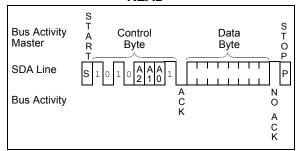
Read operations are initiated in much the same \underline{w} ay as write operations, with the exception that the R/\overline{W} bit of the control byte is set to '1'. There are three basic types of read operations: current address read, random read and sequential read.

8.1 Current Address Read

The 24AA256UID contains an address counter that maintains the address of the last word accessed, internally incremented by '1'. Therefore, if the previous read access was to address 'n' (n is any legal address), the next current address read operation would access data from address n + 1.

Upon receipt of the control byte with R/W bit set to '1', the 24AA256UID issues an acknowledge and transmits the 8-bit data word. The master will not acknowledge the transfer, but does generate a Stop condition and the 24AA256UID discontinues transmission (Figure 8-1).

FIGURE 8-1: CURRENT ADDRESS READ



8.2 Random Read

Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, the word address must first be set. This is done by sending the word address to the 24AA256UID as part of a write operation (R/W bit set to '0'). Once the word address is sent, the master generates a Start condition following the acknowledge. This terminates the write operation, but not before the internal Address Pointer is set. The master then issues the control byte again, but with the R/\overline{W} bit set to a one. The 24AA256UID will then issue an acknowledge and transmit the 8-bit data word. The master will not acknowledge the transfer, though it does generate a Stop condition, which causes the 24AA256UID to discontinue transmission (Figure 8-2). After a random Read command, the internal address counter will point to the address location following the one that was just read.

8.3 Sequential Read

Sequential reads are initiated in the same way as a random read except that after the 24AA256UID transmits the first data byte, the master issues an acknowledge as opposed to the Stop condition used in a random read. This acknowledge directs the 24AA256UID to transmit the next sequentially addressed 8-bit word (Figure 8-3). Following the final byte transmitted to the master, the master will NOT generate an acknowledge, but will generate a Stop provide sequential condition. To reads. 24AA256UID contains an internal Address Pointer which is incremented by one at the completion of each operation. This Address Pointer allows the entire memory contents to be serially read during one operation. The internal Address Pointer will automatically roll over from address 7FFF to address 0000 if the master acknowledges the byte received from the array address 7FFF.

FIGURE 8-2: RANDOM READ

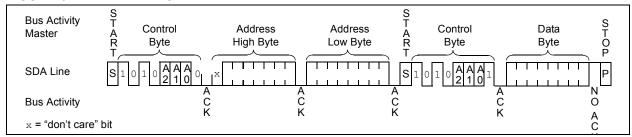
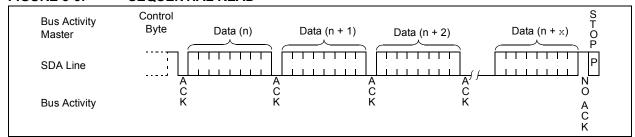


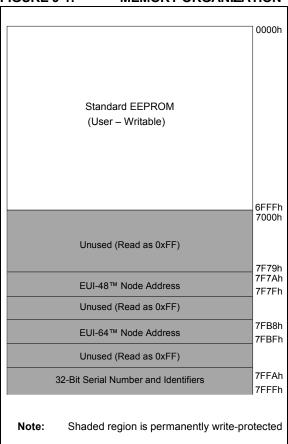
FIGURE 8-3: SEQUENTIAL READ



9.0 PRE-PROGRAMMED SERIAL NUMBER AND NODE ADDRESSES

The 24AA256UID is programmed at the factory with globally unique EUI-48 and EUI-64 node addresses, and a 32-bit serial number stored in the upper eighth of the array and permanently write-protected. The remaining 229,376 bits are available for application use.

FIGURE 9-1: MEMORY ORGANIZATION



9.1 32-Bit Serial Number

The 24AA256UID features a unique 32-bit serial number stored in array locations 0x7FFC through 0x7FFF, as shown in Figure 9-2.

| Note: | The 32-bit serial number is unique across |
|-------|---|
| | all Microchip UID-family serial EEPROM |
| | devices. |

9.1.1 MANUFACTURER AND DEVICE IDENTIFIERS

In addition to the serial number, a manufacturer code is stored at location 0x7FFA and a device identifier is stored at 0x7FFB. The manufacturer code is fixed as 0x29. For the 24AA256UID, the device identifier is 0x48. The '4' indicates the I^2C^{TM} family and the '8' indicates a 256 Kbit memory density.

9.1.2 EXTENDING THE 32-BIT SERIAL NUMBER

For applications that require serial numbers larger than 32 bits, additional data bytes can be used to pad the provided serial number to meet the required length. Any data byte values can be used for padding as the 32-bit serial number ensures the extended serial number remains unique.

The padding can be performed in two ways. The first method is to pad the data in software by combining the 32-bit serial number from the 24AA256UID with fixed data. The second method is to extend the number of bytes read from the 24AA256UID to meet the required length. Table 9-1 shows example address ranges and their corresponding serial number lengths.

TABLE 9-1: EXTENDED READ EXAMPLES

| Start Address | End Address | Serial Number Length |
|---------------|-------------|-------------------------|
| 0x7FFC | 0x7FFF | 32 bits |
| 0x7FFA | 0x7FFF | 48 bits |
| 0x7FF8 | 0x7FFF | 64 bits |
| 0x7FF0 | 0x7FFF | 128 bits |
| 0x7FE0 | 0x7FFF | 256 bits |

FIGURE 9-2: SERIAL NUMBER PHYSICAL MEMORY MAP EXAMPLE

| Description | Manufacturer Code | Device Code | 32-bit Serial Number | | | | |
|------------------|----------------------|----------------|----------------------|-------|-------|-------|--|
| Data | 29h | 48h | 12h | 34h | 56h | 78h | |
| Туре | Fix | ed | Serialized | | | | |
| Array Address | 7FFAh | 7FFBh | 7FFCh | 7FFDh | 7FFEh | 7FFFh | |

9.2 EUI-48 Node Address

The 6-byte EUI-48 node address value is stored in array locations 0x7F7A through 0x7F7F, as shown in Figure 9-3. The first three bytes are the Organizationally Unique Identifier (OUI) assigned to Microchip by the IEEE Registration Authority. Currently, Microchip's OUIs are 0x0004A3 and 0x001EC0, though this will change as addresses are exhausted. The remaining three bytes are the Extension Identifier, and are generated by Microchip to ensure a globally unique, 48-bit value.

9.3 EUI-64 Node Address

The 8-byte EUI-64 node address value is stored in array locations 0x7FB8 through 0x7FBF, as shown in Figure 9-4. The first three bytes are the Organizationally Unique Identifier (OUI) assigned to Microchip by the IEEE Registration Authority. Currently, Microchip's OUIs are 0x0004A3 and 0x001EC0, though this will change as addresses are exhausted. The remaining five bytes are the Extension Identifier, and are generated by Microchip to ensure a globally unique, 64-bit value.

Note: In conformance with IEEE guidelines, Microchip will not use the values 0xFFFE and 0xFFFF for the first two bytes of the EUI-64 Extension Identifier. These two values are specifically reserved to allow applications to encapsulate EUI-48 addresses into EUI-64 addresses.

FIGURE 9-3: EUI-48 NODE ADDRESS PHYSICAL MEMORY MAP EXAMPLE

| Description | | it Organizatio nique Identifi | | 24-bit Extension Identifier | | | |
|------------------|-------|----------------------------------|-----|--------------------------------|-----|-------|--|
| Data | 00h | 04h | A3h | 12h | 34h | 56h | |
| Array Address | 7F7Ah | 1 | | | | 7F7Fh | |

Corresponding EUI-48™ Node Address: 00-04-A3-12-34-56

24AA256UID

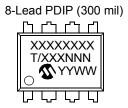
FIGURE 9-4: EUI-64 NODE ADDRESS PHYSICAL MEMORY MAP EXAMPLE

| _ | | | | | | | | | |
|------------------|--|-----|-----|--------------------------------|-----|-----|-----|-------|--|
| Description | 24-bit Organizationally Unique Identifier | | | 40-bit Extension Identifier | | | | | |
| Data | 00h | 04h | A3h | 12h | 34h | 56h | 78h | 90h | |
| Array Address | 7FB8h | | I | I | I | I | | 7FBFh | |

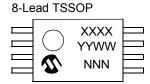
Corresponding EUI-64™ Node Address: 00-04-A3-12-34-56-78-90

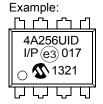
10.0 PACKAGING INFORMATION

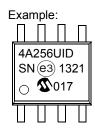
10.1 Package Marking Information

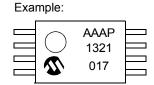










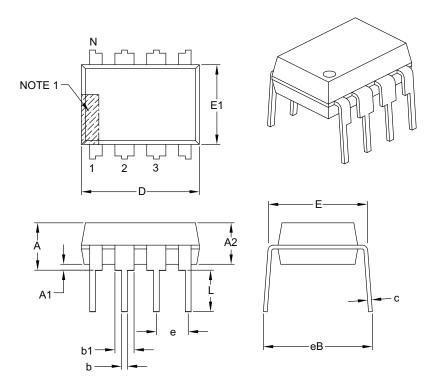


| - | | | | | | | | | | |
|---|--------|---|--|--|--|--|--|--|--|--|
| | Legend | : XXX | Part number or part number code | | | | | | | |
| | | T | Temperature (I, E) | | | | | | | |
| | | Υ | Year code (last digit of calendar year) | | | | | | | |
| | | YY | Year code (last 2 digits of calendar year) | | | | | | | |
| | | WW | Week code (week of January 1 is week '01') | | | | | | | |
| | | NNN | Alphanumeric traceability code (2 characters for small packages) | | | | | | | |
| | | e 3 | Pb-free JEDEC designator for Matte Tin (Sn) | | | | | | | |
| | | | | | | | | | | |
| | Note: | For very | small packages with no room for the Pb-free JEDEC designator | | | | | | | |
| | 11010. | , | marking will only appear on the outer carton or reel label. | | | | | | | |
| | | eg, the maning mileship appear on the outer outlet of root labor. | | | | | | | | |
| | Note: | In the event the full Microchin part number cannot be marked on one line, it will | | | | | | | | |
| | MOLG. | | In the event the full Microchip part number cannot be marked on one line, it will be carried even to the part line, thus limiting the number of available. | | | | | | | |
| | | be carried over to the next line, thus limiting the number of available characters for customer-specific information. | | | | | | | | |
| | | characters for customer-specific information. | | | | | | | | |

^{*}Standard device marking consists of Microchip part number, year code, week code, and traceability code. For device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office.

8-Lead Plastic Dual In-Line (P) - 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



| | INCHES | | | |
|----------------------------|----------|------|----------|------|
| Dimension | n Limits | MIN | NOM | MAX |
| Number of Pins | N | | 8 | |
| Pitch | е | | .100 BSC | |
| Top to Seating Plane | Α | _ | _ | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | _ | _ |
| Shoulder to Shoulder Width | Е | .290 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .348 | .365 | .400 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | С | .008 | .010 | .015 |
| Upper Lead Width | b1 | .040 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eВ | _ | _ | .430 |

Notes:

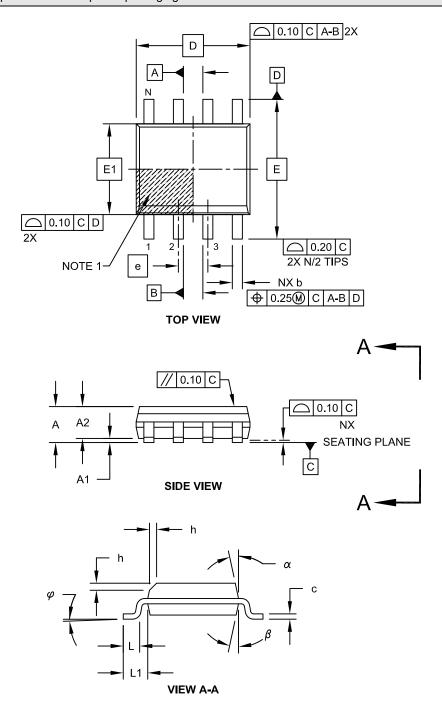
- 1. Pin 1 visual index feature may vary, but must be located with the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-018B

8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

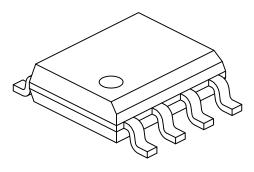
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-057C Sheet 1 of 2

8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



| Units | | MILLIMETERS | | |
|--------------------------|-----------|-------------|-----|------|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | Ν | 8 | | |
| Pitch | е | 1.27 BSC | | |
| Overall Height | Α | - | i | 1.75 |
| Molded Package Thickness | A2 | 1.25 | - | - |
| Standoff § | A1 | 0.10 | i | 0.25 |
| Overall Width | Е | 6.00 BSC | | |
| Molded Package Width | E1 | 3.90 BSC | | |
| Overall Length | D | 4.90 BSC | | |
| Chamfer (Optional) | h | 0.25 | ı | 0.50 |
| Foot Length | L | 0.40 | i | 1.27 |
| Footprint | L1 | 1.04 REF | | |
| Foot Angle | φ | 0° | - | 8° |
| Lead Thickness | С | 0.17 | İ | 0.25 |
| Lead Width | b | 0.31 | i | 0.51 |
| Mold Draft Angle Top | α | 5° | - | 15° |
| Mold Draft Angle Bottom | β | 5° | - | 15° |

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M

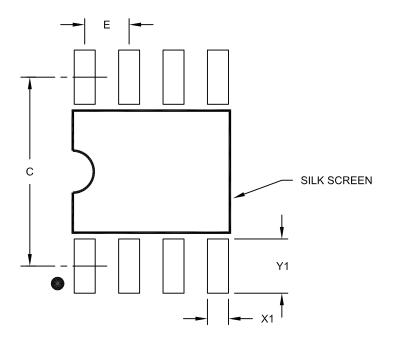
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2

8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|-------------------------|----|-------------|------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | Е | 1.27 BSC | | |
| Contact Pad Spacing | С | | 5.40 | |
| Contact Pad Width (X8) | X1 | | | 0.60 |
| Contact Pad Length (X8) | Y1 | | | 1.55 |

Notes:

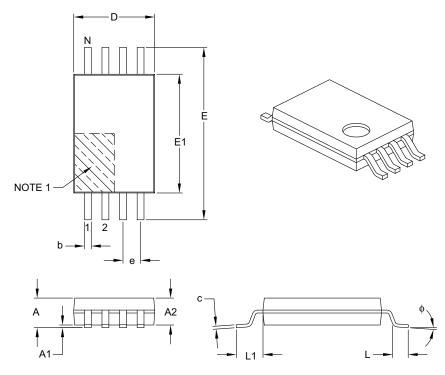
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

8-Lead Plastic Thin Shrink Small Outline (ST) – 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



| | Units | | MILLIMETERS | | |
|--------------------------|------------|----------|-------------|------|--|
| Dimensi | ion Limits | MIN | NOM | MAX | |
| Number of Pins | N | 8 | | | |
| Pitch | е | 0.65 BSC | | | |
| Overall Height | Α | - | _ | 1.20 | |
| Molded Package Thickness | A2 | 0.80 | 1.00 | 1.05 | |
| Standoff | A1 | 0.05 | _ | 0.15 | |
| Overall Width | Е | 6.40 BSC | | | |
| Molded Package Width | E1 | 4.30 | 4.40 | 4.50 | |
| Molded Package Length | D | 2.90 | 3.00 | 3.10 | |
| Foot Length | L | 0.45 | 0.60 | 0.75 | |
| Footprint | L1 | 1.00 REF | | | |
| Foot Angle | ф | 0° | _ | 8° | |
| Lead Thickness | С | 0.09 | _ | 0.20 | |
| Lead Width | b | 0.19 | _ | 0.30 | |

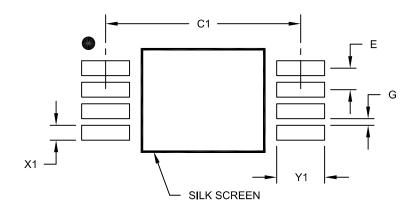
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- $2. \ \ Dimensions \ D \ and \ E1 \ do \ not include \ mold \ flash \ or \ protrusions. \ Mold \ flash \ or \ protrusions \ shall \ not \ exceed \ 0.15 \ mm \ per \ side.$
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-086B

8-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|-------------------------|----|-------------|----------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 0.65 BSC | |
| Contact Pad Spacing | C1 | | 5.90 | |
| Contact Pad Width (X8) | X1 | | | 0.45 |
| Contact Pad Length (X8) | Y1 | | | 1.45 |
| Distance Between Pads | G | 0.20 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2086A

24AA256UID

APPENDIX A: REVISION HISTORY

Revision A (06/2013)

Initial Release.

DS20005215A-page 22

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NOTES:

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| PART NO. | X /XX | Examples: |
|-----------------------|---|--|
| Device | Temperature Package Range | a) 24AA256UID-I/P: Industrial Temp., 1.7V, PDIP package. b) 24AA256UIDT-I/SN: Tape and Reel, |
| Device: | 24AA256UID = 256 Kbit 1.7V I ² C Serial EEPROM, with EUI-48 and EUI-64 Node Identities and 32-bit Serial Number 24AA256UIDT = 256 Kbit 1.7V I ² C Serial EEPROM, with EUI-48 and EUI-64 Node Identities and 32-bit Serial Number (Tape and Reel) | Industrial Temp., 1.7V, SOIC package. c) 24AA256UID-I/ST: Industrial Temp., 1.7V, TSSOP package. |
| Temperature Range: | I = -40°C to +85°C | |
| Package: | P = Plastic DIP (300 mil body), 8-lead SN = Plastic SOIC (3.90 mm body), 8-lead ST = Plastic TSSOP (4.4 mm), 8-lead | |



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